

INTRODUCTION

SN6A264 is a series of single chip voice/dual tone melody synthesizer IC with 16*33/8*40/4*40 direct drive capability which contains two 4-bit I/O ports and a tiny controller. By programming through the tiny controller, user's application including LCD display, section combination, trigger modes, output status, voice/melody playing and other logic functions and then be easily implemented.

■ FEATURES

- Single power supply 2.4V − 5.1V
- Built in a tiny controller
- Two 4-bit I/O ports are provided, two optional 4-bit output ports are provided
- 256*4 bits RAM for programming usage are provided
- 160*4 bits RAM for LCD display usage are provided
- Maximum 64k*10 program ROM is provided
- Readable ROM code data
- Built in direct 16*33/8*40/4*40 LCD driver
- LCD 1/4 bias, 1/5 bias; 1/8 duty, 1/16 duty
- Built in a high quality speech synthesizer
- Adaptive playing speed from 2.5k-40kHz is provided
- Built in a dual tone melody generator
- Speech/Dual tone melody mixer is provided which SN6A264 can play speech and dual tone melody simultaneously
- Fixed current D/A output is provided to drive external connected transistor for sound output
- PWM output is provided to drive external connected piezo buzzer

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■ PIN ASSIGNMENT

Symbol	I/O	Function Description
SEG1/P40 ~	0	Optional to be segment1~4 or P40~P43
SEG4/P43		SEG1~4: segment1~4 for LCD driver.
		P40~P43: bit0-bit3 for output port 4.
SEG5/P50 ~	0	Optional to be segment5~8 or P50~P53
SEG8/P53		SEG5~8: segment5~8 for LCD driver.
		P50~P53: bit0-bit3 for output port 5.
SEG9-SEG33	0	Segment 9 ~ 33 for LCD driver
SEG34/COM16-	0	Optional to be SEG34~40 or COM16~10
SEG40/COM10		SEG34~40: segment34~40 for 8*40/4*40 LCD
		driver.
		COM16-10: com16~com10 for 16*33 LCD driver.
COM9	0	Com9 for 16*33 LCD driver.
COM8-COM1	0	Com8-Com1 for 16*33/8*40/4*40 LCD driver.
GND	I	Negative power supply.
P33-P30	I/O	Bit 3 to bit 0 of I/O port 3.
P23-P20	I/O	Bit 3 to bit 0 of I/O port 2.
BU1,BU2	0	Buzzer driver outputs.
VO	0	D/A current output.
RESET	I	Reset pin with internal pull low.
OSC	I	Oscillation component connection pin.
TEST	I	For testing only.
XIN,XOUT		32768 Hz Crystal connection pins.
V_{DD}	I	Positive power supply.
VLCDR		LCD voltage adjusting pin.
VLC1-VLC5		LCD voltage bias connection pins.
WSUB	I	Well substrate of chip. Connected to the highest
		voltage of chip (VDD or VLCDR).

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■ ABSOLUTELY MAXIMUM RATING

Items	Symbol	Min	Max	Unit.
Supply Voltage	V _{DD} -V	-0.3	6.0	V
Input Voltage	V _{IN}	V _{SS} -0.3	V _{DD} +0.3	V
Operating Temperature	T _{OP}	-20.0	70.0	°C
Storage Temperature	T _{STG}	-55.0	125.0	°C

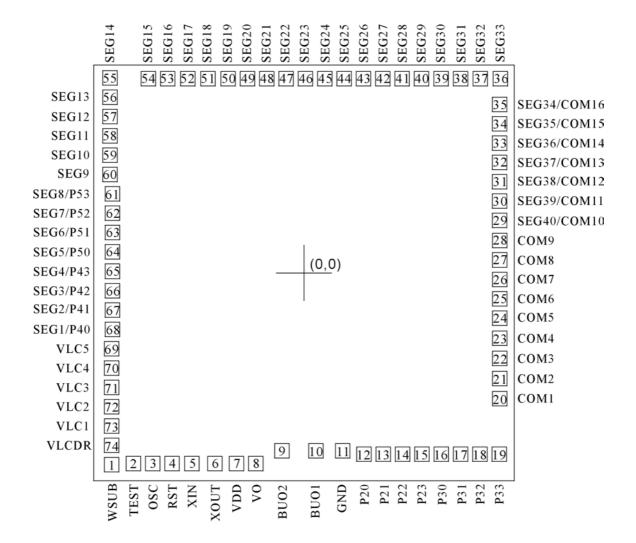
■ ELECTRICAL CHARACTERISTIC

Item	Sym.	Min.	Тур.	Max.	Unit	Condition
Operating Voltage	V_{DD}	2.4	3.0	5.1	V	
Standby current 1	I _{SBY1}	-	-	1.0	иA	V _{DD} =3V,both system clk and 32768 Hz clk are off
Standby current 2	I _{SBY2}	ı	20	50	иA	V _{DD} =3V, system clk is off, 32768 Hz clk is on for LCD display and timer.
Operating current	I _{OPR}	ı	350	500	uA	V _{DD} =3V, no load
Input current of ,P2,P3	_H	1	3.0	10.0	uA	V_{DD} =3 V , V_{IN} =3 V
Drive current of P2,P3,P4,P5	I _{OD}	-1.5	-2	-	mA	V_{DD} =3V, V_{O} =2.6V
large Sink current of P2,P3,P4,P5	I _{OS1}	2.0	3	-	mA	V_{DD} =3 V , V_{O} =0.4 V
Small Sink current of P2,P3,P4,P5	I _{OS2}	-	0.4	-	uA	V_{DD} =3 V , V_{O} =0.4 V
D/A output current	I _{VO}	2.0	3.0	4.0	mA	V_{DD} =3V, V_{O} =0.7V
Buzzer drive current	I _{BZD}		-15		mA	V_{DD} =3 V , V_{O} =1.5 V
Buzzer sink current	I _{BZS}		15		mA	V_{DD} =3 V , V_{O} =1.5 V
Oscillation resistor	R	-	1.0		MHZ	V _{DD} =3V
Oscillation Freq.	Fosc	-	1.0	-	MHZ	V _{DD} =3V

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BONDING PAD



SN6A264

Note: The substrate MUST be connected to Vss in PCB layout.



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